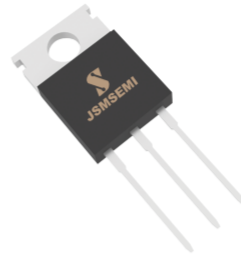
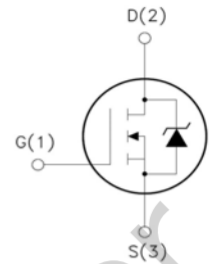


Features:

- ◆ Low Intrinsic Capacitances.
- ◆ Excellent Switching Characteristics.
- ◆ Extended Safe Operating Area.
- ◆ Unrivalled Gate Charge : $Q_g=117\text{nC}$ (Typ.).
- ◆ $BVDSS=100\text{V}, I_D=120\text{A}$
- ◆ $R_{DS(on)} : 3.3\text{m}\Omega$ (typ.) @ $V_G=10\text{V}$
- ◆ 100% Avalanche Tested



TO-220



- 1.Gate (G)
- 2.Drain (D)
- 3.Source (S)

Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	100	V
Continuous drain current $T_C = 25^\circ\text{C}$ (Package limit) $T_C = 100^\circ\text{C}$ (Package limit)	I_D	120 90	A
Pulsed drain current $T_C = 25^\circ\text{C}$, t_p limited by T_{jmax}	$I_{D \text{ pulse}}$	480	
Avalanche energy, single pulse ($L=0.033\text{mH}, V_{DS}=80\text{V}$)	E_{AS}	600	mJ
Gate-emitter voltage	V_{GS}	± 20	V
Power dissipation $T_C = 25^\circ\text{C}$	P_{tot}	227	W
Operating junction and storage temperature	T_j, T_{stg}	-55...+150	$^\circ\text{C}$

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal resistance, junction – case. Max	R_{thJC}	0.55	$^\circ\text{C}/\text{W}$
Thermal resistance, junction – ambient. Max	R_{thJA}	62.0	

Electrical Characteristic, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Test Condition	Value			Unit
			min.	typ.	max.	
Static Characteristic						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	100	115	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$ $T_j=25^{\circ}C$ $T_j=125^{\circ}C$	2.0 -	3	4.0 -	
Zero gate voltage drain current	I_{DSS}	$V_{DS}=80V, V_{GS}=0V$ $T_j=25^{\circ}C$ $T_j=125^{\circ}C$	- -	0.05	1 5	μA
Gate-source leakage current	I_{GSS}	$V_{GS}=20V, V_{DS}=0V$	-	1	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=50A,$ $T_j=25^{\circ}C$ $T_j=125^{\circ}C$	- -	3.3	4.0 -	m Ω
Transconductance	g_{fs}	$V_{DS}=50V, I_D=20A$	-	47	-	S
Dynamic Characteristic						
Input Capacitance	C_{iss}	$V_{GS}=0V, V_{DS}=50V,$ $f=1MHz$	-	6900	-	pF
Output Capacitance	C_{oss}		-	1250	-	
Reverse Transfer Capacitance	C_{rss}		-	47	-	
Gate Total Charge	Q_G	$V_{GS}=10V, V_{DS}=50V,$ $I_D=20A, f=1MHz$	-	117	-	nC
Gate-Source charge	Q_{gs}		-	40	-	
Gate-Drain charge	Q_{gd}		-	37	-	
Turn-on delay time	$t_{d(on)}$	$T_j=25^{\circ}C, V_{GS}=10V,$ $V_{DS}=50V, R_L=2.5\Omega$		48		ns
Rise time	t_r			56		
Turn-off delay time	$t_{d(off)}$			75		
Fall time	t_f			33		
Gate resistance	R_G	$V_{GS}=0V, V_{DS}=0V,$ $f=1MHz$	-	2.6	-	Ω
Body Diode Characteristic						
Body Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_{SD}=50A$	-	0.85	1.3	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F=20A,$ $dI/dt=500A/\mu s$		60		ns
Body Diode Reverse Recovery Charge	Q_{rr}	$I_F=20A,$ $dI/dt=500A/\mu s$		560		nC

Typical Performance Characteristics

Figure 1. Typ. Output Characteristics

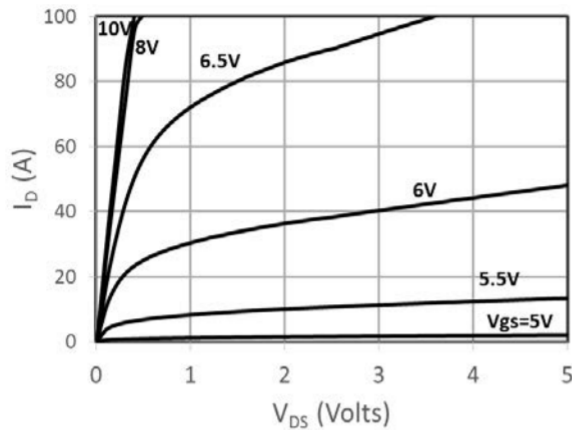


Figure 2. Transfer Characteristics (Junction Temperature)

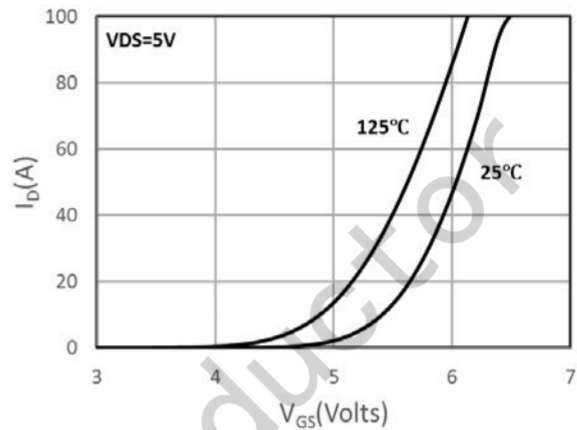


Figure 3. On-Resistance vs. Drain Current and Gate Voltage Figure

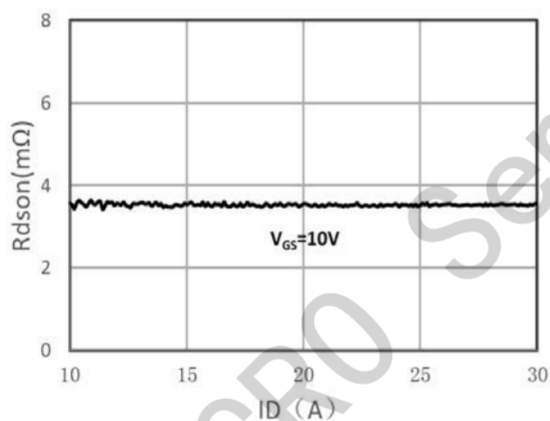


Figure 4. On-Resistance vs. Junction Temperature

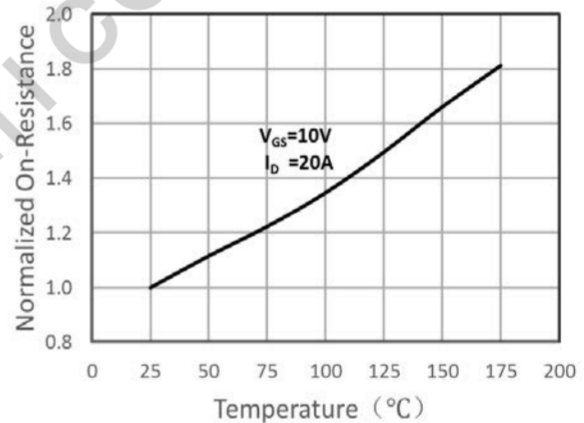


Figure 5. On-Resistance vs. Gate-Source Voltage (Junction Temperature)

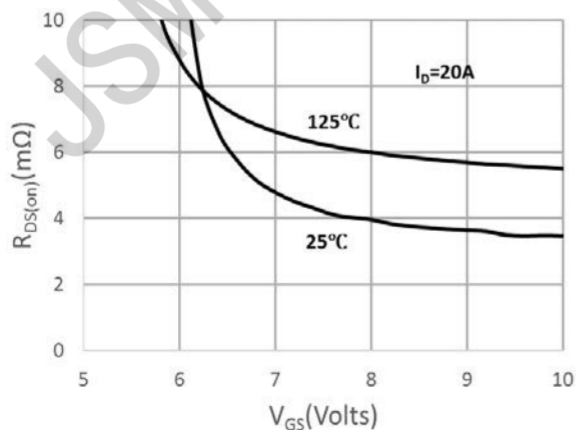


Figure 6. Body-Diode Characteristics (Junction Temperature)

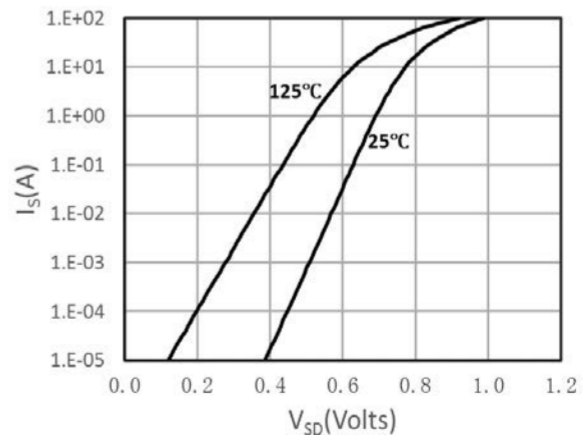


Figure 7. Gate-Charge Characteristics

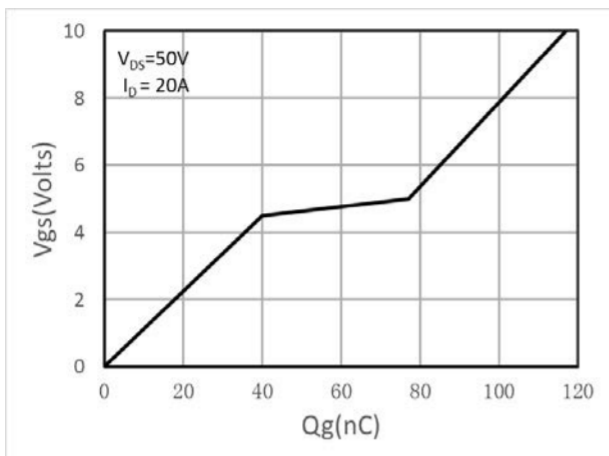


Figure 8. Capacitance Characteristics

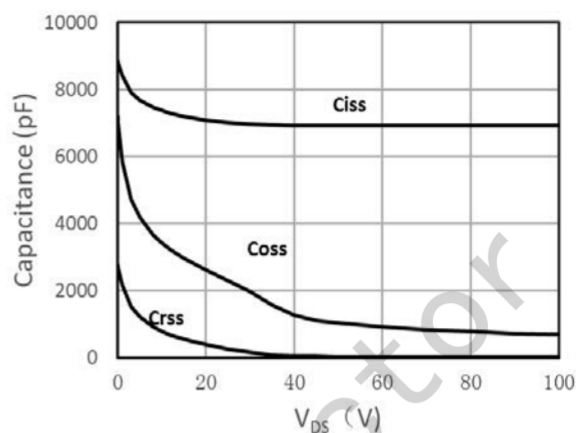


Figure 9: Normalized Maximum Transient Thermal Impedance (R_{thJC})

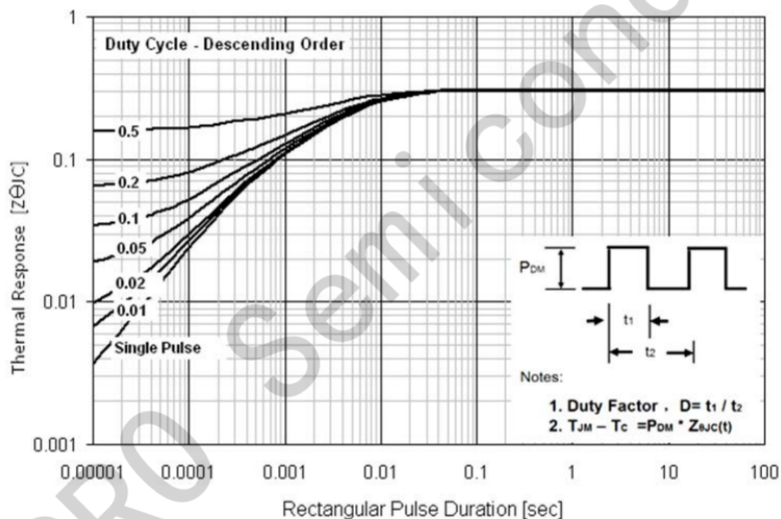


Figure 10: Normalized Maximum Transient Thermal Impedance (R_{thJA})

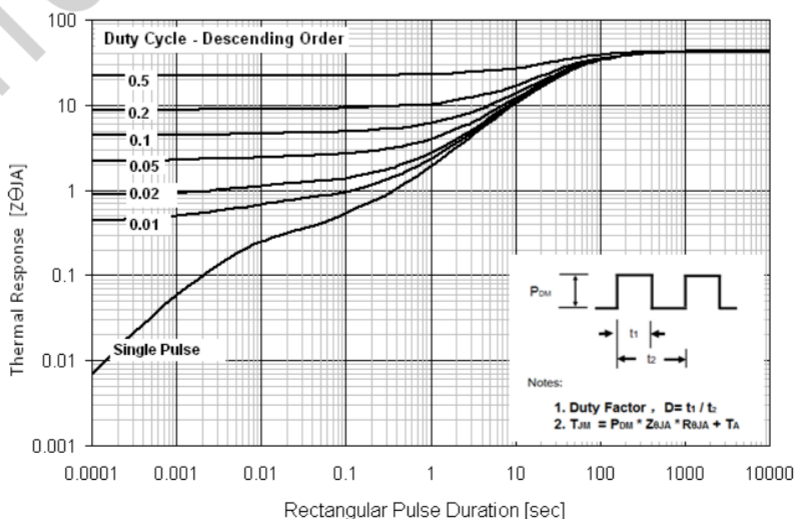


Fig 11 Typical Source-Drain Diode Forward Voltage

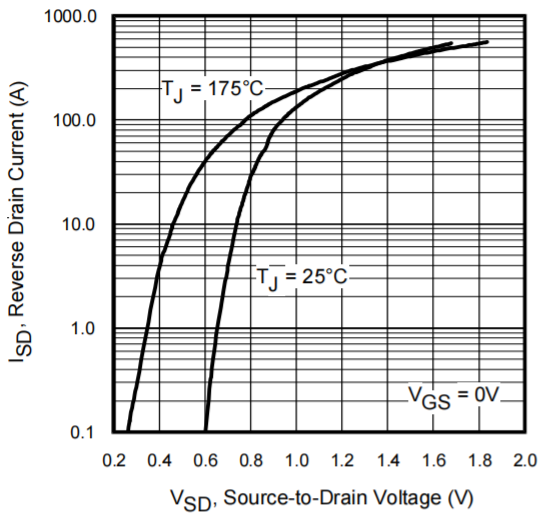


Fig 12 Maximum Safe Operating Area

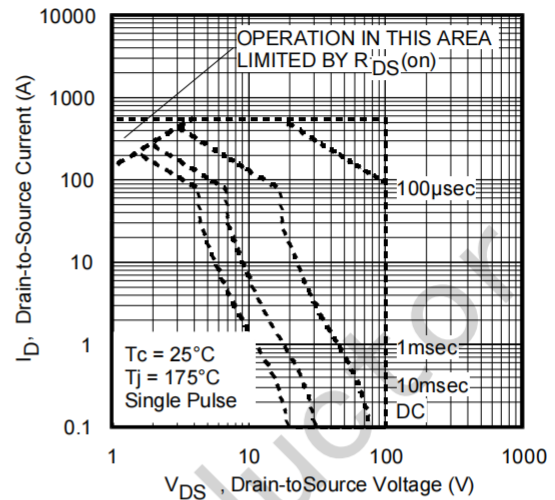


Fig 13 Maximum Drain Current vs. Case Temperature

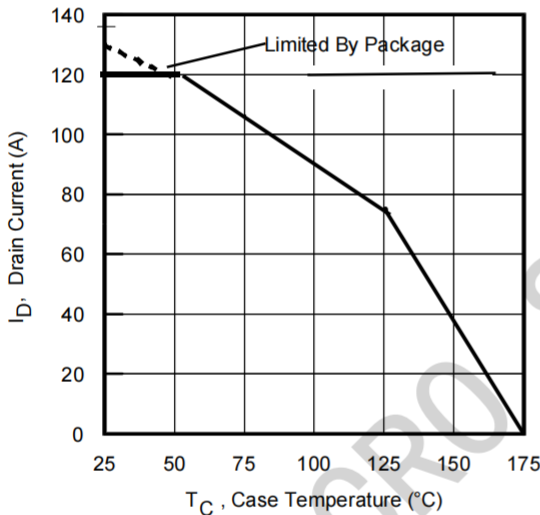


Fig 14 Drain-to-Source Breakdown Voltage

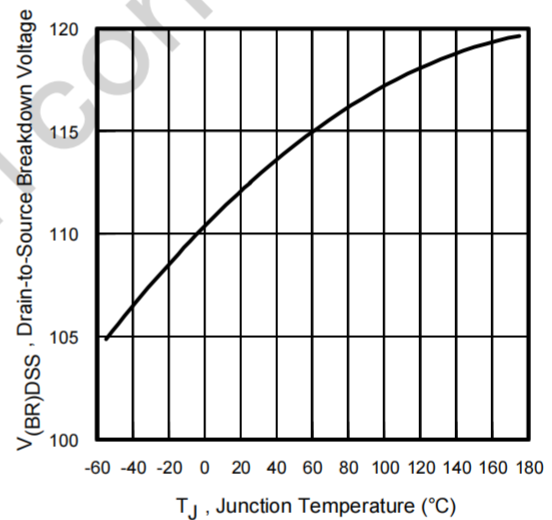


Fig 15 Typical C_{OSS} Stored Energy

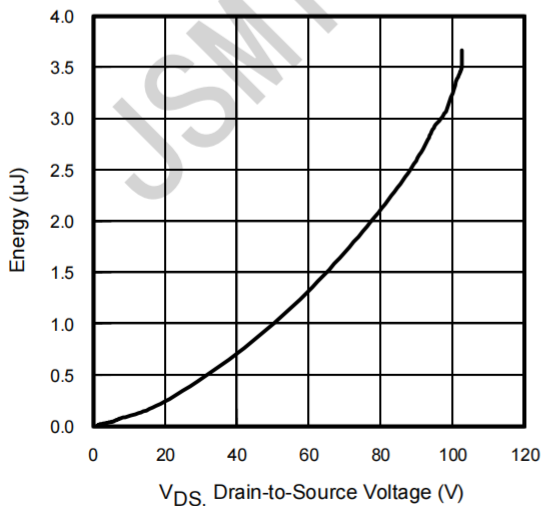
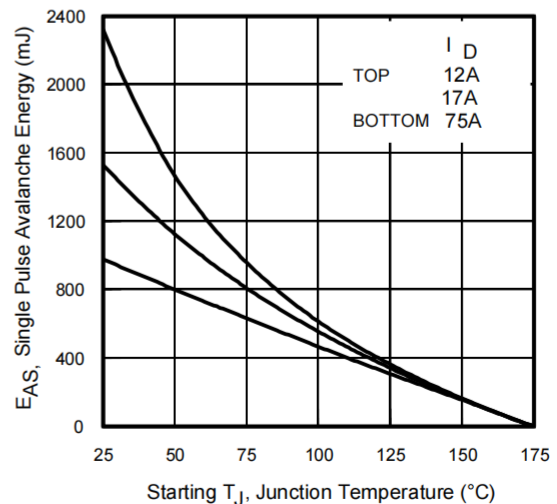
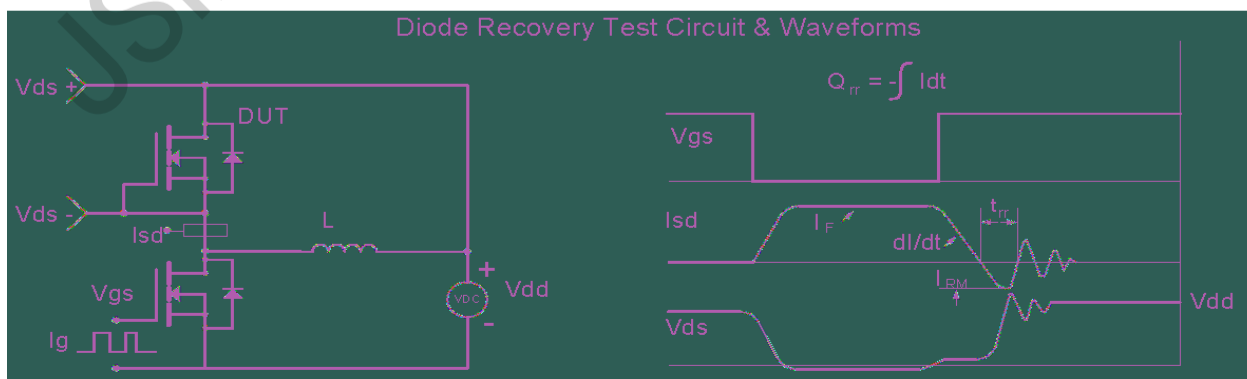
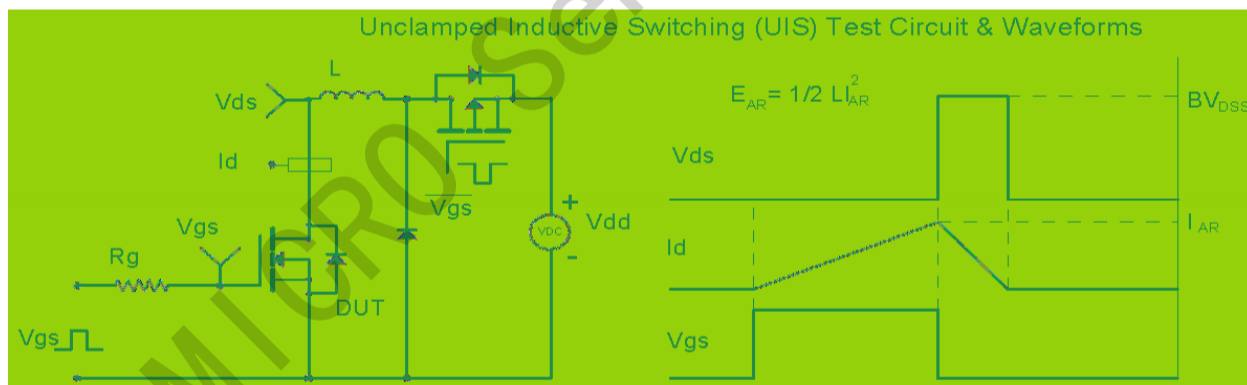
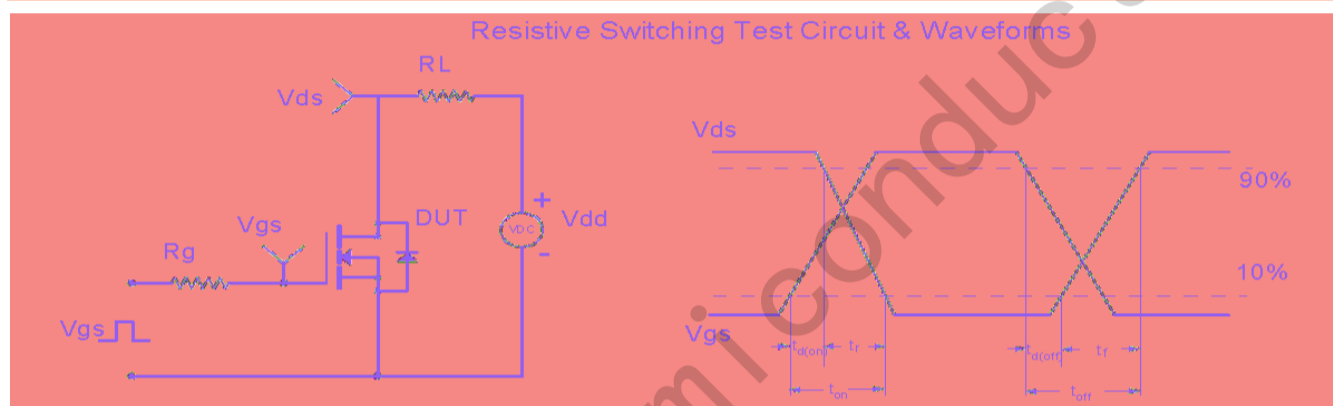
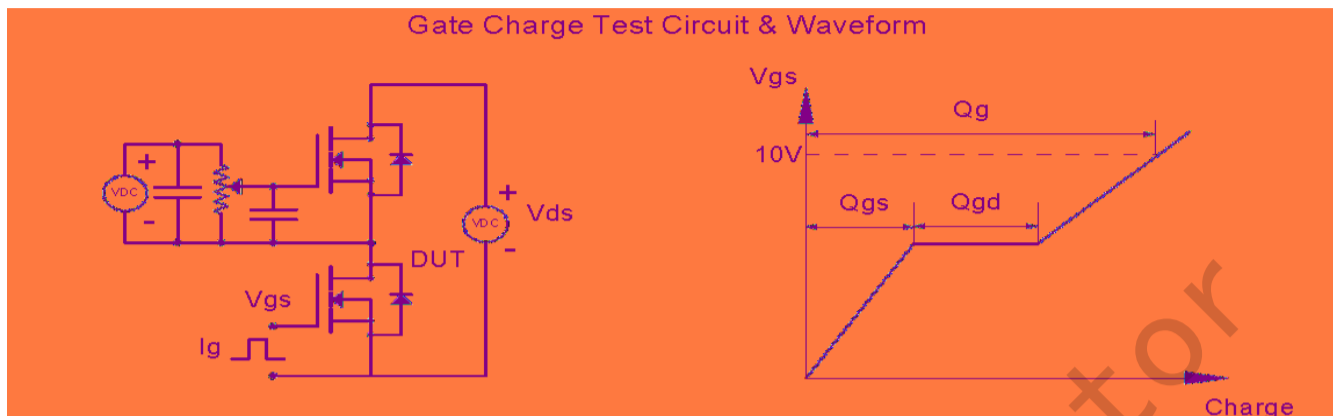


Fig 16 Maximum Avalanche Energy Vs. Drain Current

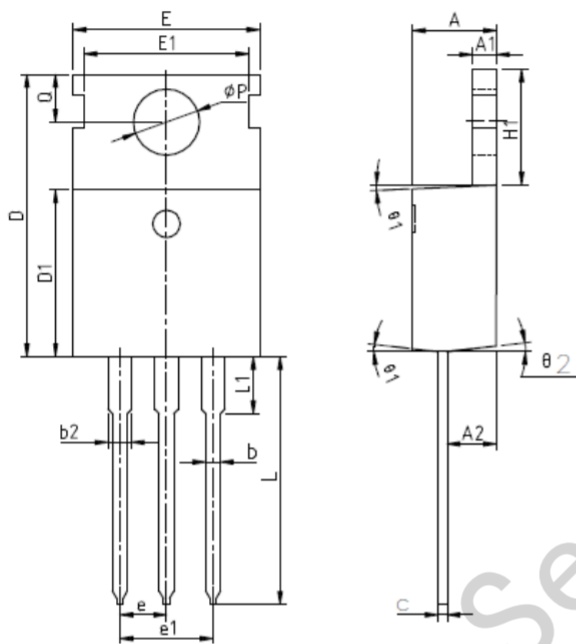


Test Circuit & Waveform



Package Dimension

TO-220



SYMBOL	MIN	NOM	MAX
A	4.27	4.57	4.87
A1	1.15	1.30	1.45
A2	2.10	2.40	2.70
b	0.70	0.80	1.00
b2	1.17	1.27	1.50
c	0.40	0.50	0.65
D	15.10	15.60	16.10
D1	8.80	9.10	9.40
D2	5.70	6.70	7.00
E	9.70	10.00	10.30
E1	-	8.70	-
E2	9.65	10.00	10.35
E3	7.00	8.00	8.40
e	2.54 BSC		
e1	5.08 BSC		
H1	6.00	6.50	6.85
L	12.75	13.50	13.90
L1	-	3.10	3.40
ΦP	3.45	3.60	3.75
Q	2.60	2.80	3.00
θ1	4°	7°	10°
θ2	0°	3°	6°